1.5A LOW DROPOUT VOLTAGE CMOS REGULATOR

Description

The PAM3110 is a 1.5A CMOS LDO regulator that features a low quiescent current and low dropout voltages, as well as over temperature shutdown. The fixed output voltage of the PAM3110 is set at the factory and trimmed to ±1.5%. The PAM3110 is stable with a ceramic output capacitor of 4.7µF or higher.

This family of regulators can provide either a stand-alone power supply solution or act as a post regulator for switch mode power supplies. They are particularly suitable for applications requiring low input and output voltages.

PAM3110 is available in SOT-223, TO-252 and TO-263-2L package.

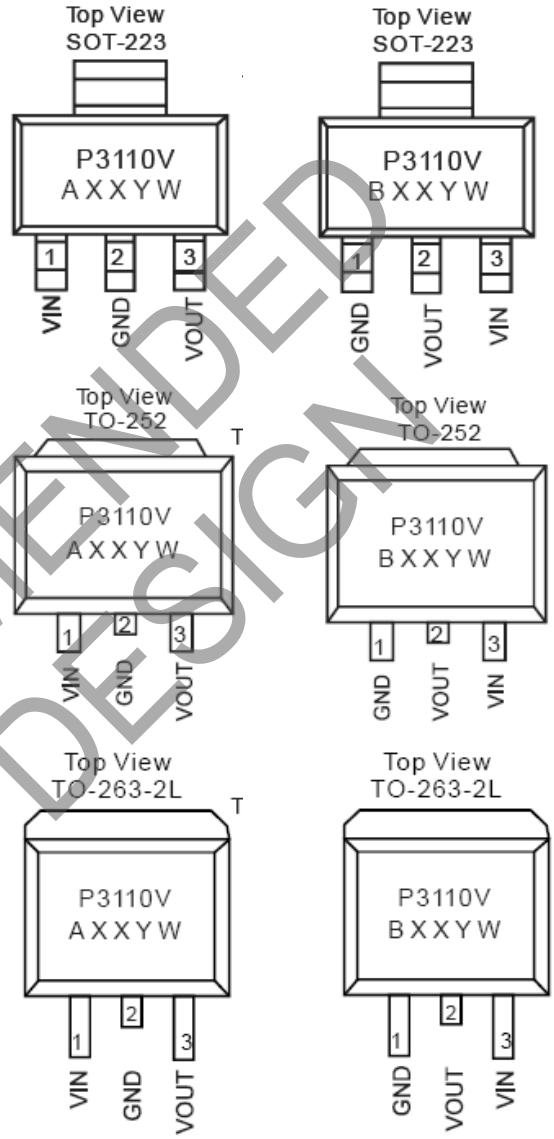
Features

- DSP, FPGA and Microprocessor Power Supplies
- Output Voltages:1.2V, 1.5V,1.8V, 2.5V 3.3V and 5.0V
- Stable with a Ceramic Output Capacitor
- Dropout Voltage: 400mV@1.5A
- Low Quiescent Current
- Over Temperature Shutdown
- Short Circuit Protection
- Low Temperature Coefficient
- Pb-Free Packages

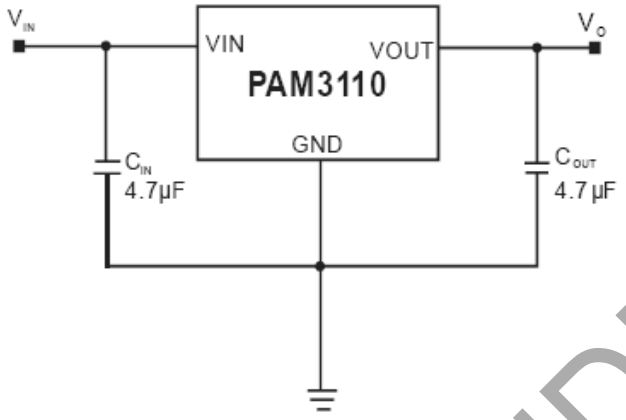
Applications

- DSP, FPGA and Microprocessor Power Supplies
- SATA Power Supply
- LCD TV/Monitors
- Wireless Devices
- Communication Devices
- Portable Electronics
- Post Regulator for SMS

Pin Assignments



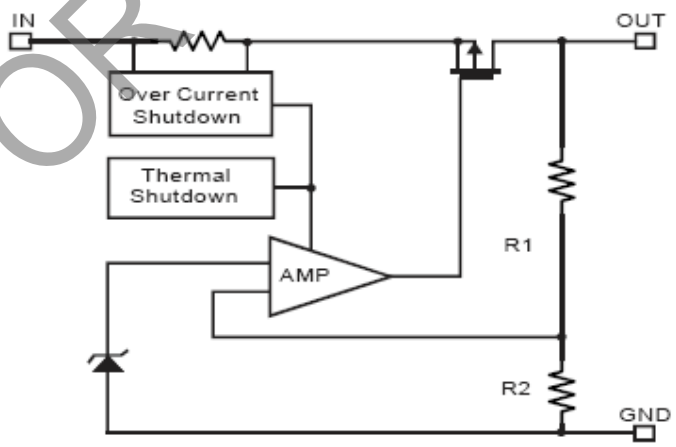
Typical Applications Circuit



Pin Configuration and Description

Pin Name	Pin Number		Function
	SOP-8(EP)	W-DFN3x3-10	
VIN	3	7, 8, 9	Supply Input Voltage.
EN	2	6	Chip Enable (Active-High).
CTRL	4	10	Supply Voltage of ControlCircuitry.
POK	1	5	Power Good Open Drain Output.
ADJ	7	4	Set the output voltage by the feedback resistors. V_O = 0.8V x (R1 + R2)/R2.
VOUT	6	1, 2, 3	Output Voltage.
NC	5	—	No Internal Connection.
GND	8, Exposed Pad (9)	Exposed Pad (11)	Ground. The exposed pad must be soldered to a large PCB and connected to GND formaximum powe r dissipation.

Functional Block Diagram



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

These are stress ratings only and functional operation is not implied. Exposure to absolute maximum ratings for prolonged time periods may affect device reliability. All voltages are with respect to ground.

Parameter	Rating	Unit
Input Voltage	6	V
Storage Temperature	-65 to +150	°C
Maximum Junction Temperature	150	°C
Lead Soldering Temperature	300, (5sec)	°C

Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

Parameter	Rating	Unit
Supply Voltage	2.5 to 5.5	V
Ambient Temperature Range	-40 to +85	°C
Junction Temperature Range	-40 to +125	

Thermal Information

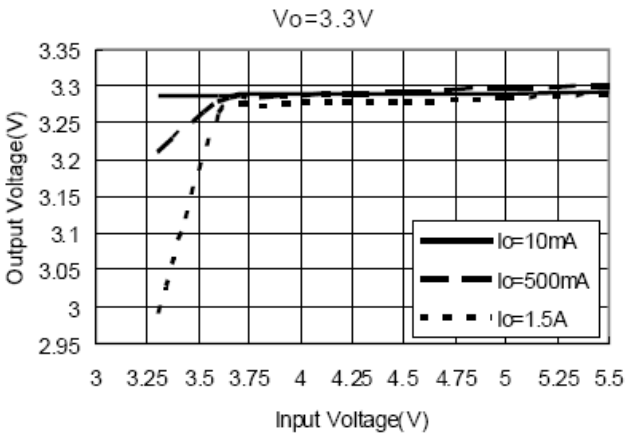
Parameter	Symbol	Package	Max	Unit
Thermal Resistance Junction to Case)	θ_{JC}	SOT-223	7	°C/W
		TO-252	7	
		TO-263	7	
Thermal Resistance (Junction to Ambient)	θ_{JA}	SOT-223	160	
		TO-252	90	
		TO-263	60	
Internal Power Dissipation (@T_A = 25°C)	P_D	SOT-223	625	mW
		TO-252	1200	
		TO-263	2000	

Electrical Characteristics (@T_A = +25°C, V_{IN} = V_O +0.5V, V_{CTRL} = V_{EN} = 5V, C_{IN} = C_O = 10µF, unless otherwise specified.)

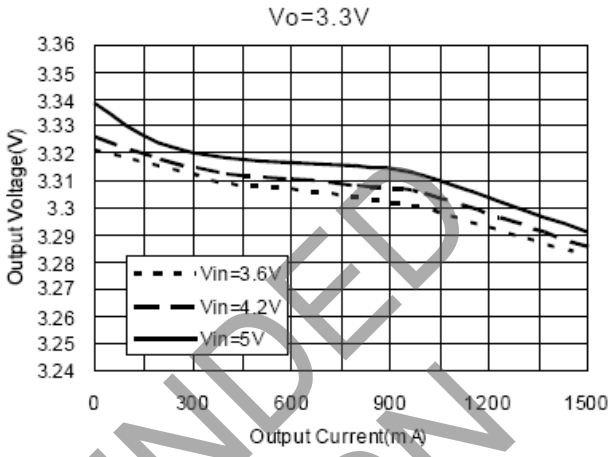
Parameter	Symbol	Test Conditions		Min	Typ	Max	Units
Input Voltage Range	V_{IN}			2.5		5.5	V
Output Voltage Accuracy	V_O	I_O = 1mA to 1.5A		-1.5		1.5	%
Dropout Voltage	V_{DROP}	I_O = 500mA	V_O ≥ 2.5V		200		mV
		I_O = 1.5A	V_O ≥ 2.5V		400		
Short Circuit Current	I_{SC}	V_O < 0.3V			500		mA
Quiescent Current	I_Q	I_O = 0mA			75	150	µA
Current Limit	I_{LIM}				2		A
Line Regulation	LNR	V_O ≤ 2.5V, I_O = 10mA V_{IN} = V_O +1.5V to V_O +2.5V			0.5	1	%/V
		V_O > 2.5V, I_O = 10mA V_{IN} = V_O +0.5V to V_O +1.5V					
Load Regulation	LDR	I_O = 1mA to 100A			0.5	1	%
Over Temperature Shutdown	OTS				160		°C
Over Temperature Hysteresis	OTH				30		°C
Temperature Coefficient	T_C				40		ppm/°C
Power Supply Ripple Rejection	PSRR	I_O = 100mA	f = 100Hz		55		dB
			f = 1kHz		50		
			f = 10kHz		35		

Typical Performance Characteristics (@T_A = +25°C, C_{IN} =4.7µF, C_{OUT} = 4.7µF, unless otherwise specified.)

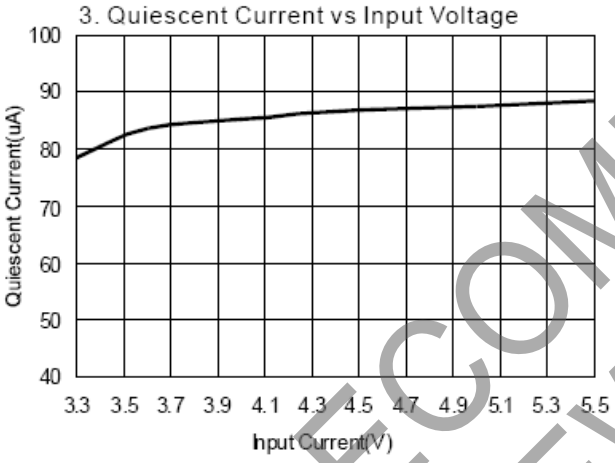
1. Output Voltage vs Input Voltage



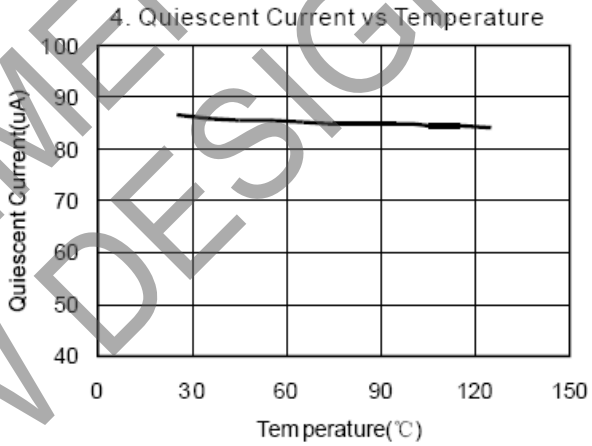
2. Output Voltage vs Output Current



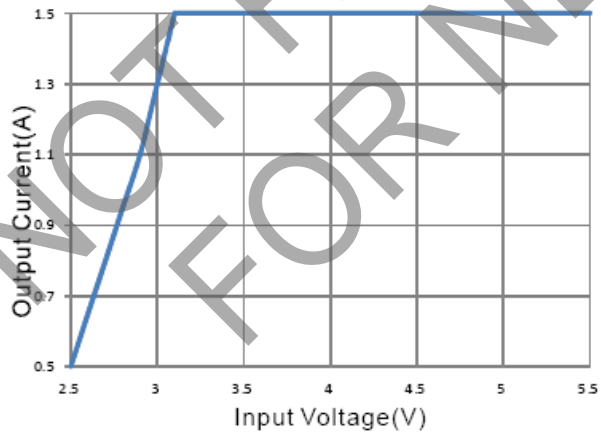
3. Quiescent Current vs Input Voltage



4. Quiescent Current vs Temperature

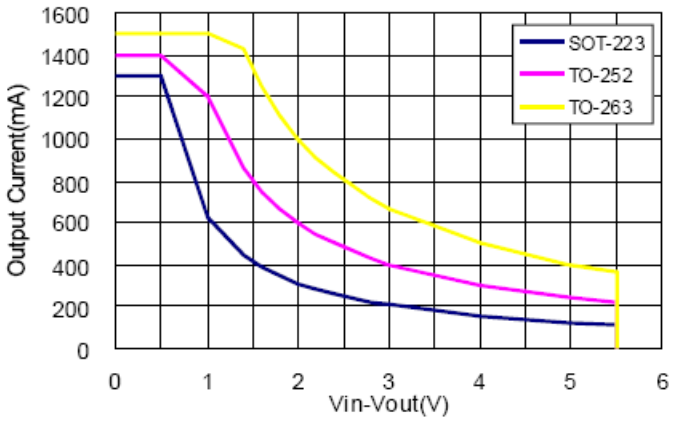


5. Maximum Output Current vs Input Voltage

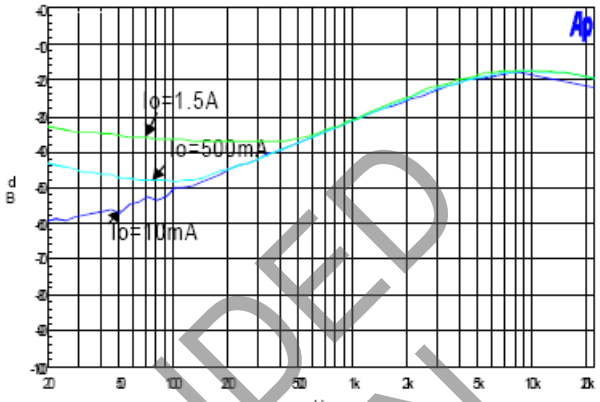


Typical Performance Characteristics (cont.) (@T_A = +25°C, C_{IN} =4.7µF, C_{OUT} = 4.7µF, unless otherwise specified.)

6. Safety Operation Area

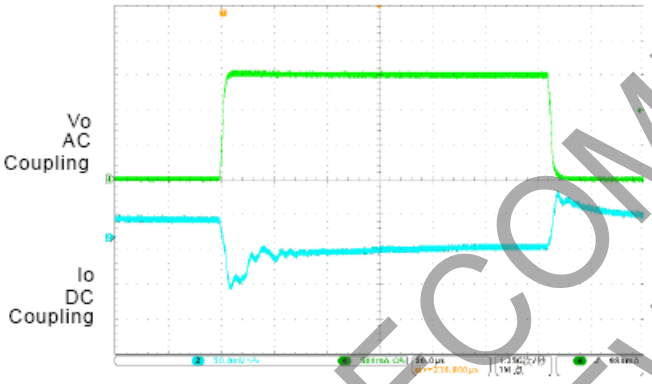


7. Ripple Rejection vs Frequency



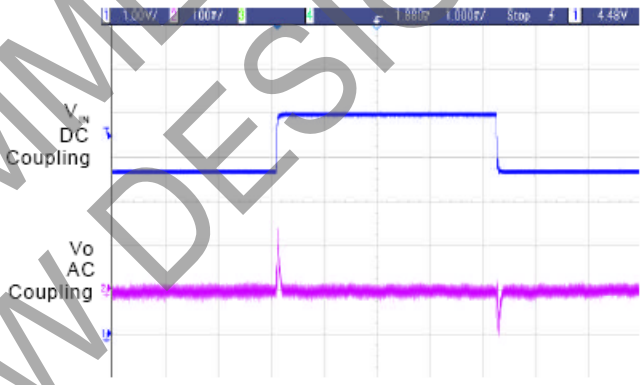
Vo=3.3V,V_{IN}=4.2V,Vpp=1V

8. Load Transient Response



Vo=3.3V ,V_{IN}=5V, Io=0mA to 1.5A

9. Line Transient Response



Vo=3.3V, V_{IN}=3.8V to 5V, Io=10mA

Application Information

The PAM3110 family of low-dropout (LDO) regulators have several features that allow them to apply to a wide range of applications. The family operates with very low input voltage and low dropout voltage (typically 300mV at full load), making it an efficient stand-alone power supply or post regulator for battery or switch mode power supplies. The 1.5A output current make the PAM3110 family suitable for powering many microprocessors and FPGA supplies.

External Capacitor Requirements

A 4.7µF or larger ceramic input bypass capacitor, connected between V_{IN} and GND and located close to the PAM3110, is required for stability. A 4.7µF minimum value capacitor from V_O to GND is also required. To improve transient response, noise rejection, and ripple rejection, an additional 1 0µF or larger, low ESR capacitor is recommended at the output. A higher-value, low ESR output capacitor may be necessary if large, fast-rise-time load transients are anticipated and the device is located several inches from the power source, especially if the minimum input voltage of 2.5V is used.

Regulator Protection

The PAM3110 features internal current limiting, thermal protection and short circuit protection. During normal operation, the PAM3110 limits output current to about 2A. When current limiting engages, the output voltage scales back linearly until the over current condition ends. While current limiting is designed to prevent gross device failure, care should be taken not to exceed the power dissipation ratings of the package. If the temperature of the device exceeds +150°C, thermal-protection circuitry will shut down. Once the device has cooled down to approximately +30°C below the high temp trip point, regulator operation resumes. The short circuit current of the PAM3110 is about 0.5A when its output pin is shorted to ground.

Thermal Information

The amount of heat that an LDO linear regulator generates is:

$$P_D = (V_{IN} - V_O)I_O$$

All integrated circuits have a maximum allowable junction temperature ($T_{J(MAX)}$) above which normal operation is not assured. A system designer must design the operating environment so that the operating junction temperature ($T_{J(MAX)}$) does not exceed the maximum junction temperature ($T_{J(MAX)}$). The two main environmental variables that a designer can use to improve thermal performance are air flow and external heat sinks. The purpose of thi s information is to aid the designer in determining the proper operating environment for a linear regulator that is operating at a specific power level.

In general, the maximum expected power ($P_{D(MAX)}$) consumed by a linear regulator is computed as:

Where:

- $V_{I(AVG)}$ is the average input voltage.
- $V_{O(AVG)}$ is the average output voltage.
- $I_{O(AVG)}$ is the average output current.
- $I_{(Q)}$ is the quiescent current.

For most LDO regulators, the quiescent current is insignificant compared to the average output current; therefore, the term $V_{I(AVG)}$ xI $I_{(Q)}$ can be neglected. The operating junction temperature is computed by adding the ambient temperature (T_A) and the increase in temperature due to the regulator's power dissipation. The temperature rise is computed by multiplying the maximum expected power dissipation by the sum of the thermal resistances between the junction and the case ($R_{\theta JC}$), the case to heatsink ($R_{\theta CS}$), and the heatsink to ambient ($R_{\theta SA}$). Thermal resistances are measures of how effectively an object dissipates heat. Typically, the larger the device, the more surface area available for power dissipation so that the object's thermal resistance will be lowers.

Ordering Information

PAM3110 X X X xxx X

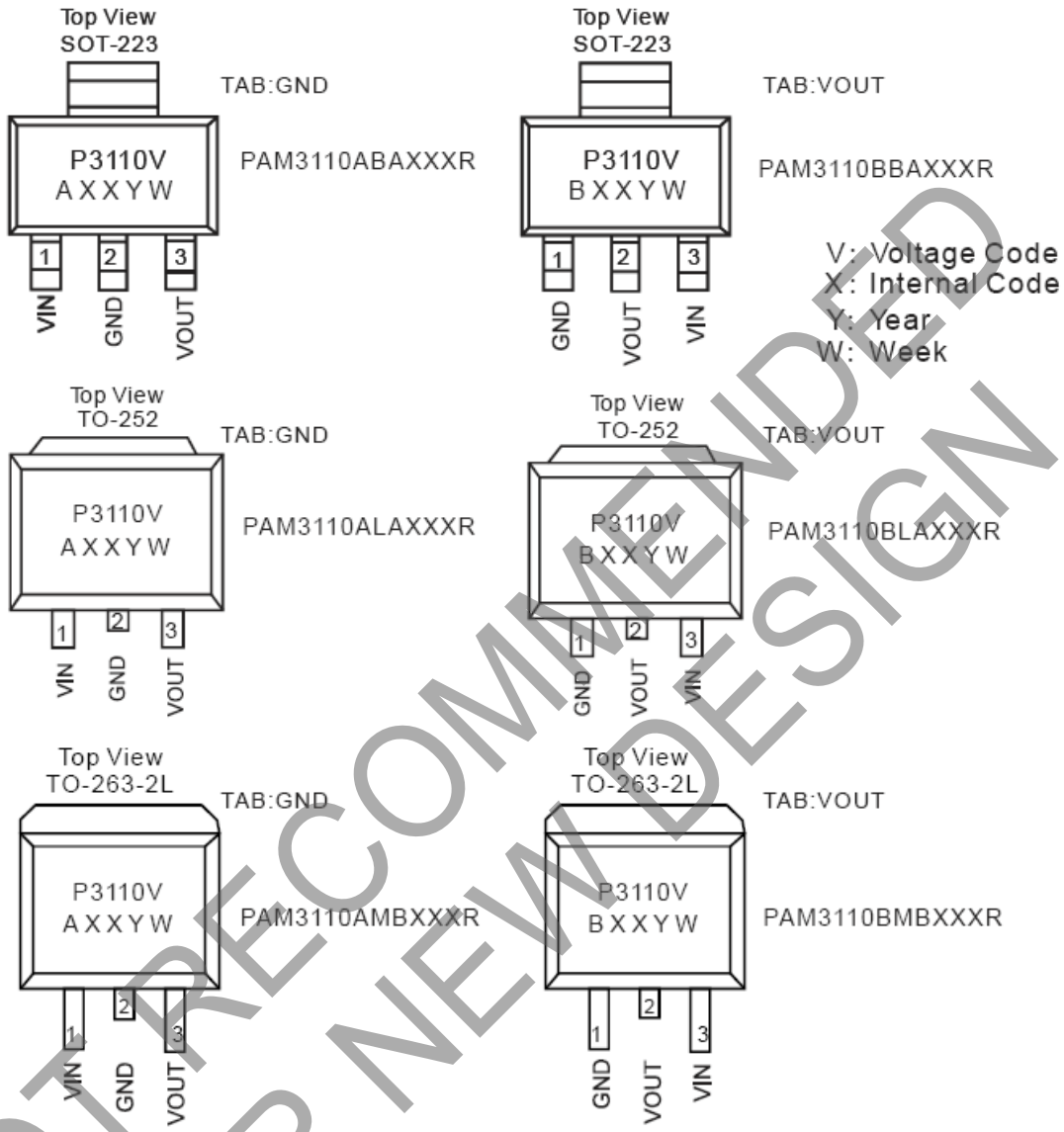
Pin Configuration	Package Type	Number of Pins	Output Voltage	Shipping Package
A Type: 1. VIN 2. GND 3. VOUT B Type: 1. GND 2. VOUT 3. VIN	B: SOT-223 L: TO-252 M: TO-263	A: 3 B: 2	120: 1.2V 150: 1.5V 180: 1.8V 250: 2.5V 330: 3.3V 500: 5.0V	R: Tape & Reel

Part Number	Output Voltage	Marking	Package Type	Standard Package
PAM3110ABA120R	1.2V	P3110B AXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110BBA120R	1.2V	P3110B BXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110ALA120R	1.2V	P3110B BXXYW	TO-252	2500 Units/Tape&Reel
PAM3110BLA120R	1.2V	P3110B BXXYW	TO-252	2500 Units/Tape&Reel
PAM3110AMB120R	1.2V	P3110B BXXYW	TO-263-2L	800 Units/Tape&Reel
PAM3110BMB120R	1.2V	P3110B BXXYW	TO-263-2L	800 Units/Tape&Reel
PAM3110ABA150R	1.5V	P3110C AXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110BBA150R	1.5V	P3110C BXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110ALA150R	1.5V	P3110C AXXYW	TO-252	2500 Units/Tape&Reel
PAM3110BLA150R	1.5V	P3110C BXXYW	TO-252	2500 Units/Tape&Reel
PAM3110AMB150R	1.5V	P3110C AXXYW	TO-263-2L	800 Units/Tape&Reel
PAM3110BMB150R	1.5V	P3110C BXXYW	TO-263-2L	800 Units/Tape&Reel
PAM3110ABA180R	1.8V	P3110E AXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110BBA180R	1.8V	P3110E BXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110ALA180R	1.8V	P3110E AXXYW	TO-252	2500 Units/Tape&Reel
PAM3110BLA180R	1.8V	P3110E BXXYW	TO-252	2500 Units/Tape&Reel
PAM3110AMB180R	1.8V	P3110E AXXYW	TO-263-2L	800 Units/Tape&Reel
PAM3110BMB180R	1.8V	P3110E BXXYW	TO-263-2L	800 Units/Tape&Reel

Ordering Information (cont.)

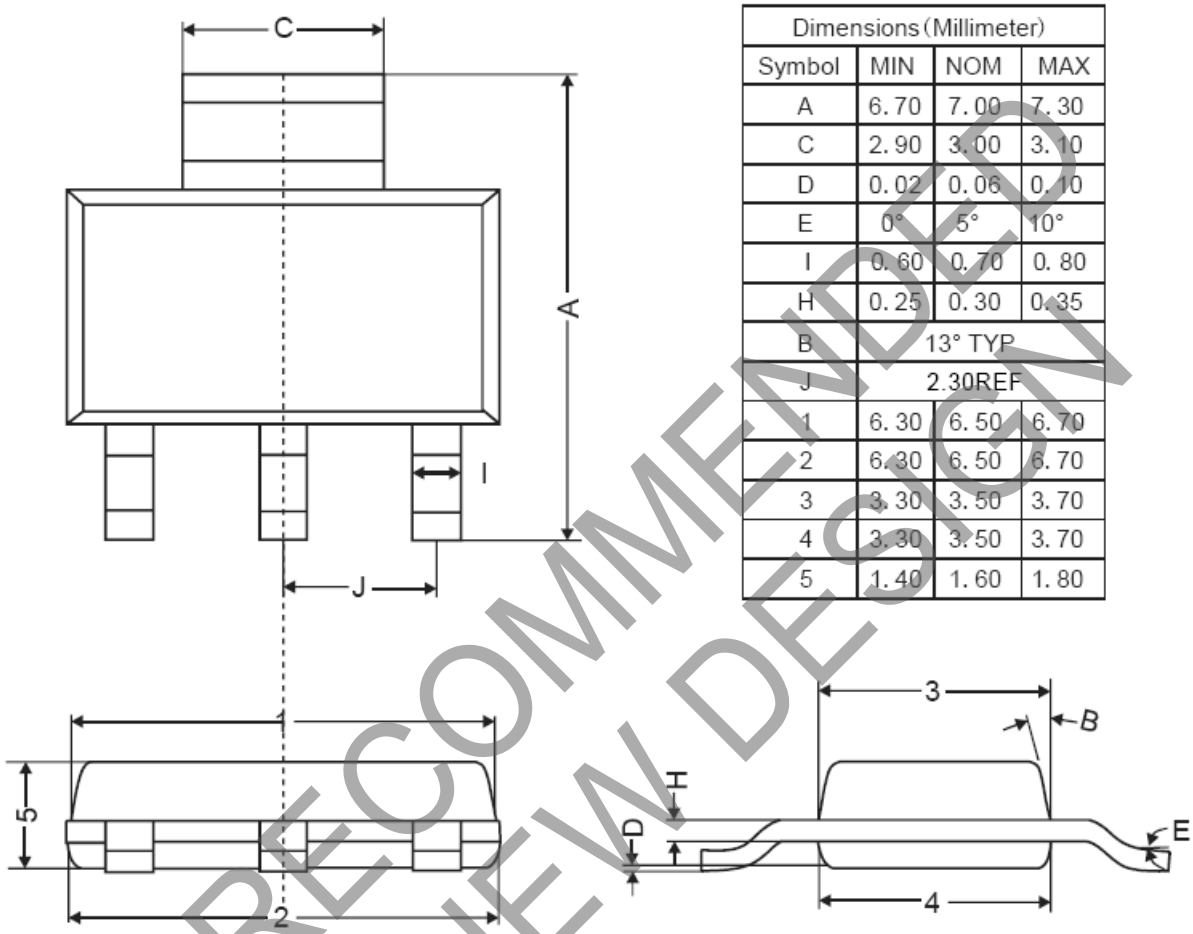
Part Number	Output Voltage	Marking	Package Type	Standard Package
PAM3110ABA250R	2.5V	P3110G AXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110BBA250R	2.5V	P3110G BXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110ALA250R	2.5V	P3110G AXXYW	TO-252	2500 Units/Tape&Reel
PAM3110BLA250R	2.5V	P3110G BXXYW	TO-252	2500 Units/Tape&Reel
PAM3110AMB250R	2.5V	P3110G AXXYW	TO-263-2L	800 Units/Tape&Reel
PAM3110BMB250R	2.5V	P3110G BXXYW	TO-263-2L	800 Units/Tape&Reel
PAM3110ABR330R	3.3V	P3110K AXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110BBA330R	3.3V	P3110K BXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110ALA330R	3.3V	P3110K AXXYW	TO-252	2500 Units/Tape&Reel
PAM3110BLA330R	3.3V	P3110K BXXYW	TO-252	2500 Units/Tape&Reel
PAM3110AMB330R	3.3V	P3110K AXXYW	TO-263-2L	800 Units/Tape&Reel
PAM3110BMB330R	3.3V	P3110K BXXYW	TO-263-2L	800 Units/Tape&Reel
PAM3110ABA500R	5.0V	P3110L AXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110BBA500R	5.0V	P3110L BXXYW	SOT-223	2500 Units/Tape&Reel
PAM3110ALA500R	5.0V	P3110L AXXYW	TO-252	2500 Units/Tape&Reel
PAM3110BLA500R	5.0V	P3110L BXXYW	TO-252	2500 Units/Tape&Reel
PAM3110AMB500R	5.0V	P3110L AXXYW	TO-263-2L	800 Units/Tape&Reel
PAM3110BMB500R	5.0V	P3110L BXXYW	TO-263-2L	800 Units/Tape&Reel

Marking Information



Package Outline Dimensions (All dimensions in mm.)

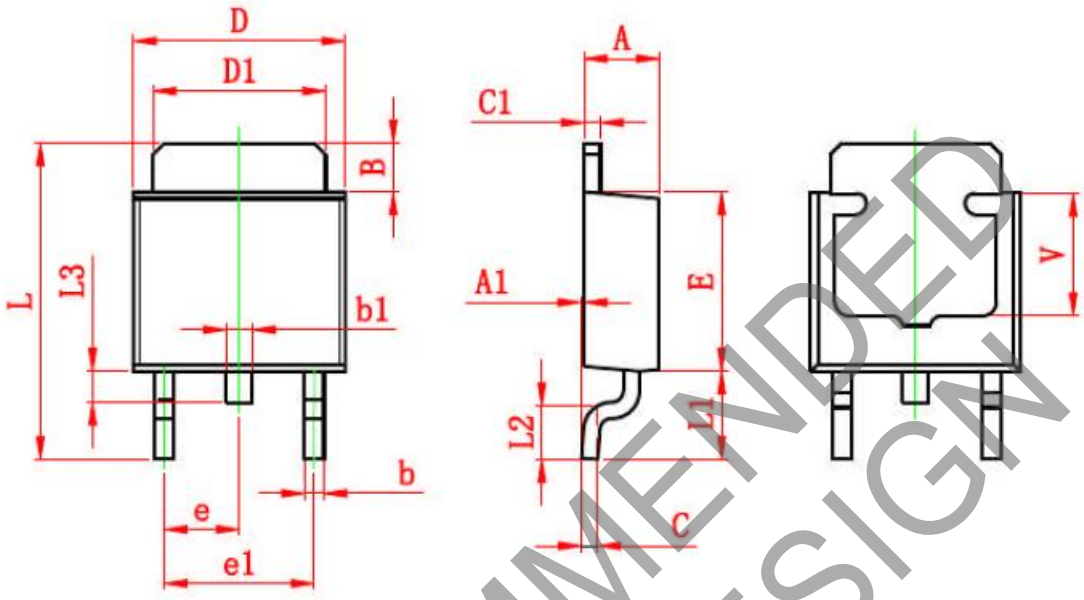
SOT-223



Dimensions (Millimeter)			
Symbol	MIN	NOM	MAX
A	6.70	7.00	7.30
C	2.90	3.00	3.10
D	0.02	0.06	0.10
E	0°	5°	10°
I	0.60	0.70	0.80
H	0.25	0.30	0.35
B	13° TYP		
J	2.30REF		
1	6.30	6.50	6.70
2	6.30	6.50	6.70
3	3.30	3.50	3.70
4	3.30	3.50	3.70
5	1.40	1.60	1.80

Package Outline Dimensions (cont.) (All dimensions in mm.)

TO-252



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.800 REF.		0.150 REF.	

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